## EVAFLEX® 5-SE

Auto-locking, horizontal mate, 0.5 mm pitch FFC/FPC connector

Product Specifications:				
Board Pitch (mm)		0.5		
Wiping Length (mm)		1.45		
	Height	2.40 +/- 0.20		
Size (mm)	Width	Formula: 13.10 + (0.5*?p)		
	Depth	5.90 +/- 0.20		
Pin counts	Range	10 – 60		
	Available	10, 15, 22, 30, 40, 45, 50, 60		

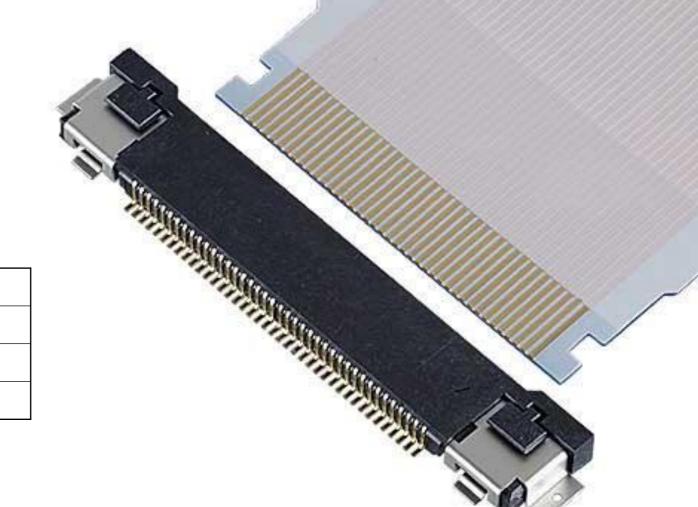
Applicable FPC/FFC:

FPC/FFC Type Non-shielded FFC/FPC

FPC/FFC Contact Point Top

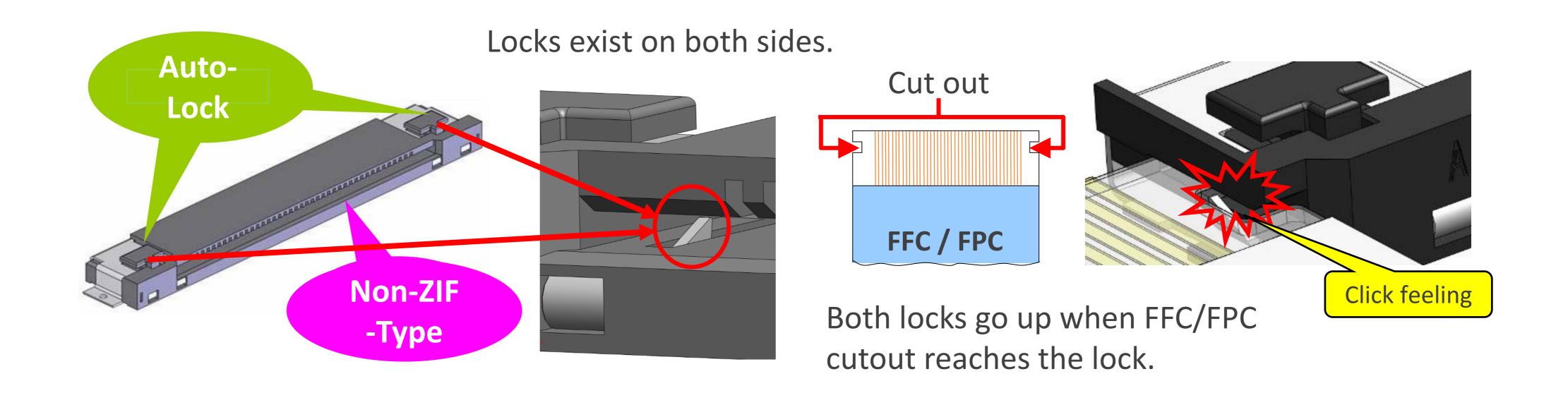
FPC/FFC Thickness FFC: 0.30 +/- 0.05

(mm) FPC: 0.30 +/- 0.03

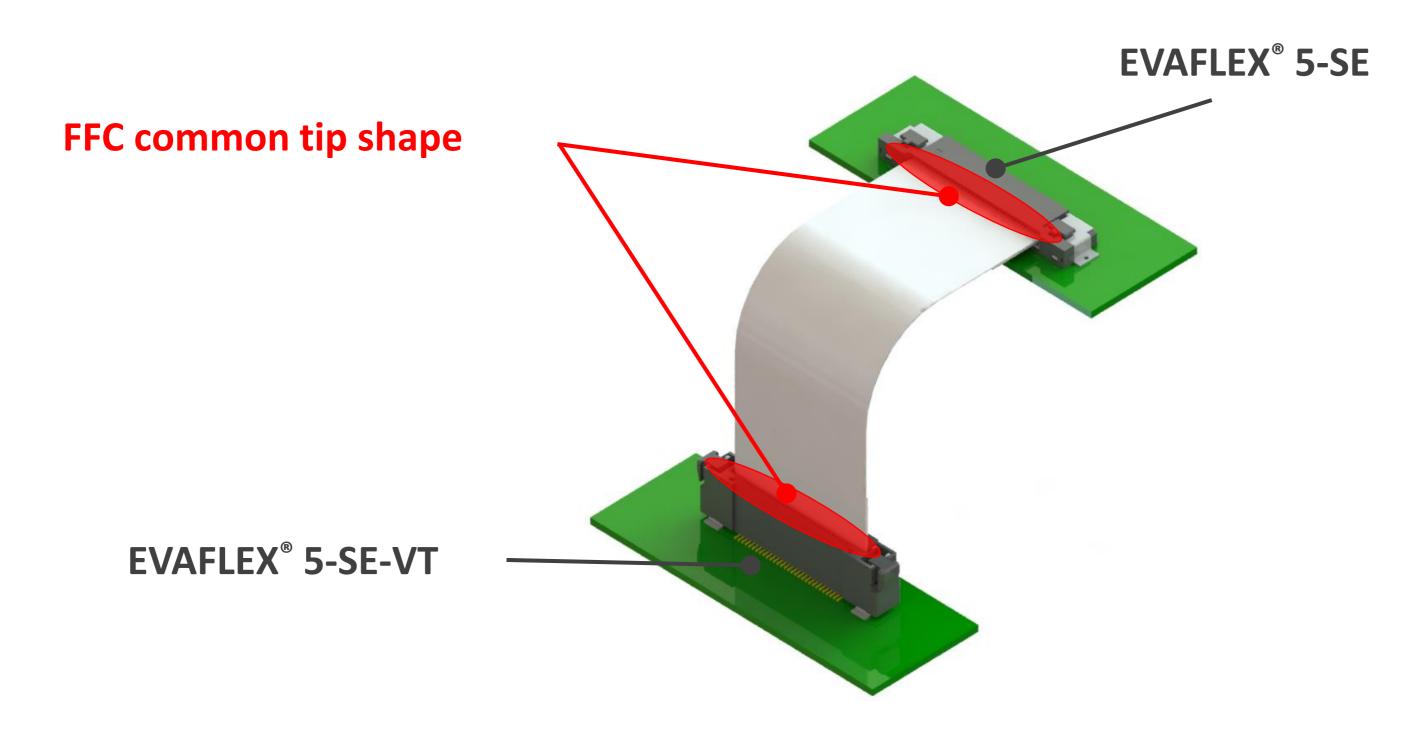


\* Please inquire for pin counts not listed or outside of the pin count range.

#### Operator friendly auto-locking design, ideal for hand or robotic assembly



#### Vertical mate type using the same FFC option as EVAFLEX® 5-SE-VT



#### Scalable EVAFLEX® family: Auto-lock connector with many other options available

Higher speed and durable to high temp (125°C): EVAFLEX® 5-SE-G HT

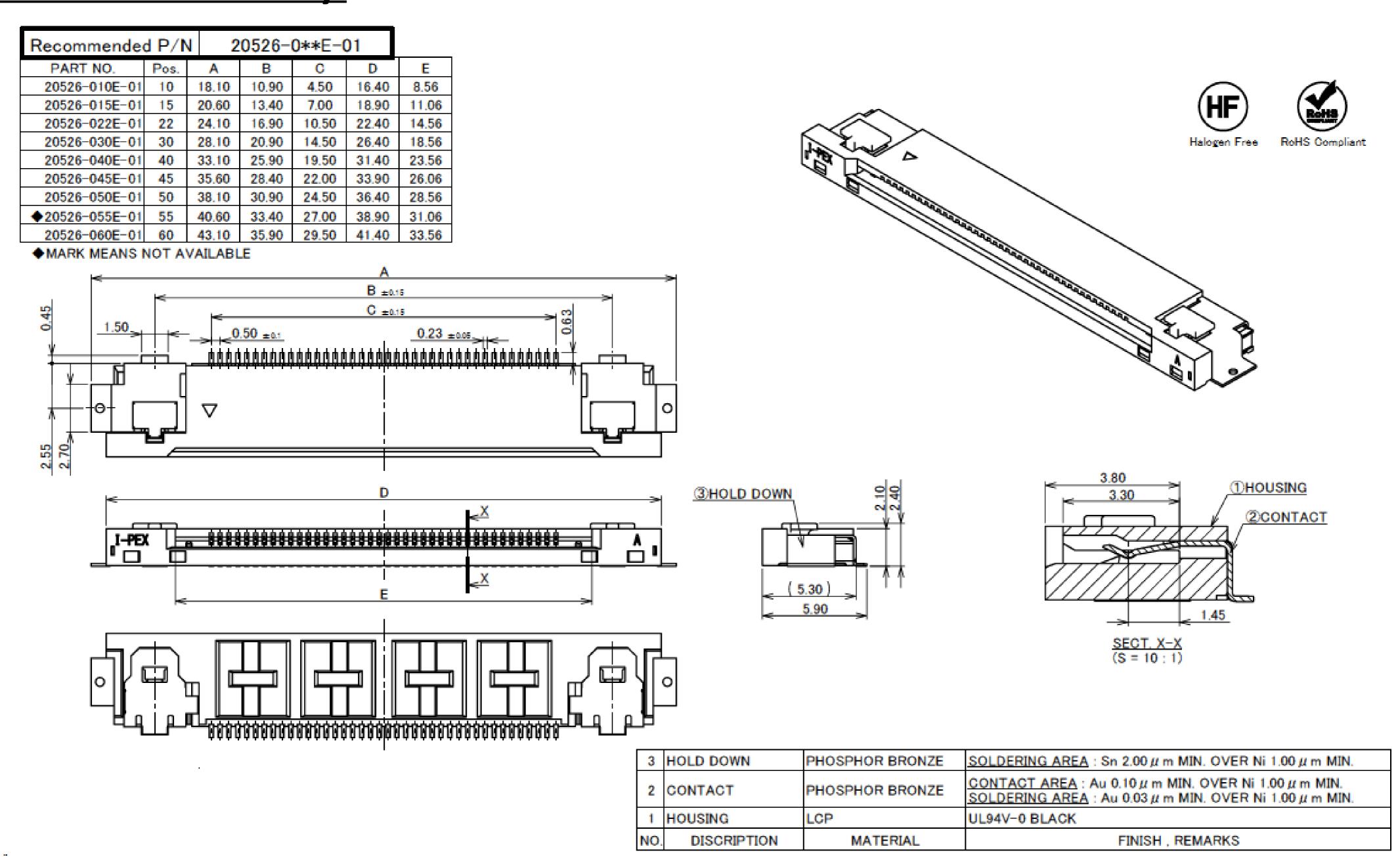
	EVAFLEX® 5-SE-G HT
Height (mm)	6.60 +/- 01
Operation Temperature	up to 125°C
Reference Performance	V-by-one HS 1.4 (4+ Gbps)





# Component Parts Details

#### **Connector Assembly**



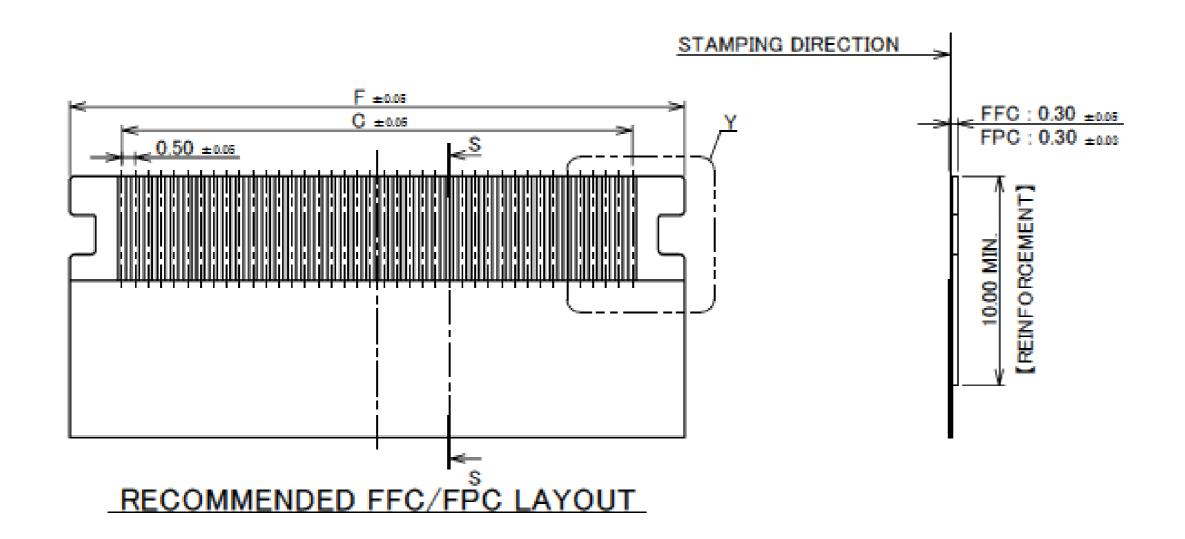
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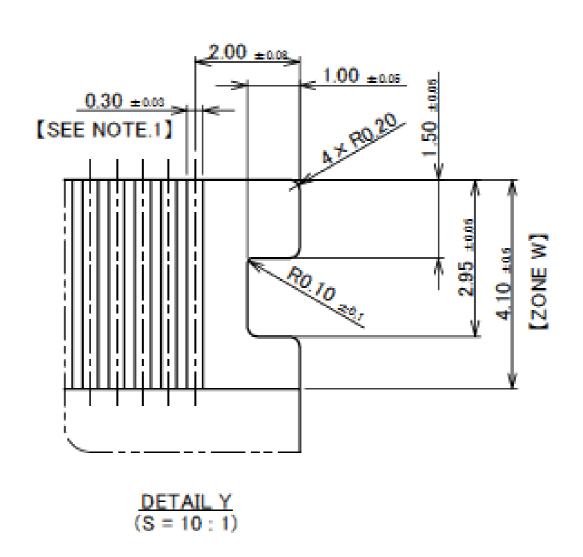


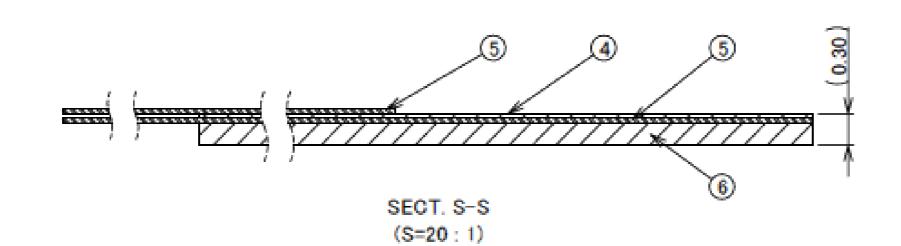
#### **Connector Assembly**

		00500 0005 01				
Recommended	Recommended P/N			20526-0**E-01		
PART NO.	Pos.	С	F			
20526-010E-01	10	4.50	8.50			
20526-015E-01	15	7.00	11.00			
20526-022E-01	22	10.50	14.50			
20526-030E-01	30	14.50	18.50			
20526-040E-01	40	19.50	23.50			
20526-045E-01	45	22.00	26.00			
20526-050E-01	50	24.50	28.50			
◆20526-055E-01	55	27.00	31.00			
20526-060E-01	60	29.50	33.50			

**<sup>◆</sup>MARK MEANS NOT AVAILABLE** 







6	REINFORCED TAPE	ARBITRARY	
5	INSULATION FILM	ARBITRARY	
4	CONDUCTOR	COPPER ALLOY	CONTACT AREA: Au 0.05 μ m MIN. OVER Ni 0.5 μ m MIN.
NO.	DISCRIPTION	MATERIAL	FINISH

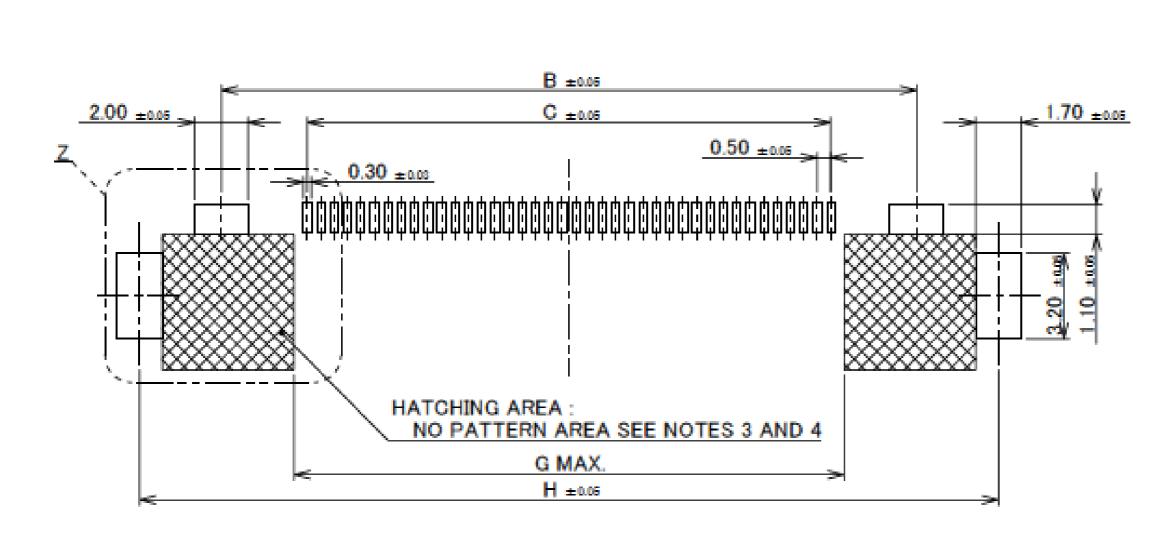
#### NOTES.

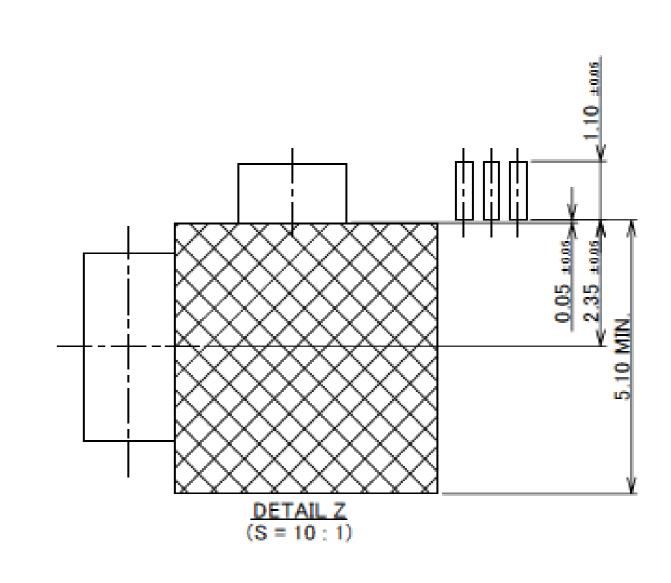
1. CONTROL DIMENSION OF [ZONE W] WITH IN 0.30±0.03 2. SELECT A MATERIAL WITH A SOFTENING TEMPERATURE OF 85°C OR HIGHER FOR THE PATTERN ADHESIVE PART OF FFC.

5	INSULATION FILM	ARBITRARY	
4	CONDUCTOR	COPPER ALLOY	CONTACT AREA: Au 0.05 μ m MIN. OVER Ni 0.5 μ m MIN.
NO.	DISCRIPTION	MATERIAL	FINISH

					· · · · · · · · · · · · · · · · · · ·
Recommende	N 2	20526-0**E-01			
PART NO.	Pos.	В	С	G	Н
20526-010E-01	10	10.90	4.50	5.50	17.00
20526-015E-01	15	13.40	7.00	8.00	19.50
20526-022E-01	22	16.90	10.50	11.50	23.00
20526-030E-01	30	20.90	14.50	15.50	27.00
20526-040E-01	40	25.90	19.50	20.50	32.00
20526-045E-01	45	28.40	22.00	23.00	34.50
20526-050E-01	50	30.90	24.50	25.50	37.00
◆20526-055E-01	55	33.40	27.00	28.00	39.50
20526-060E-01	60	35,90	29.50	30.50	42.00

**◆MARK MEANS NOT AVAILABLE** 





RECOMMENDED PCB & METALMASK LAYOUT METAL MASK THICKNESS: t=0.12

NOTES.

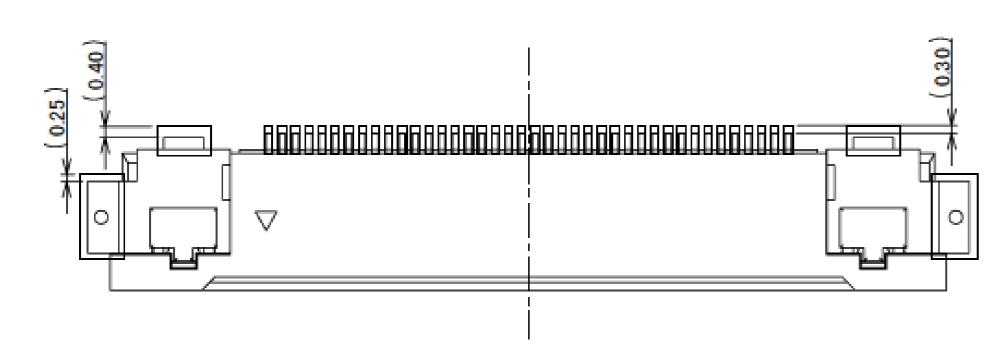
3. DO NOT MOUNT ANOTHER COMPONENTS IN THIS AREA.

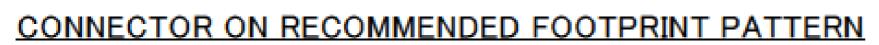
4. SOLDER RESIST MUST BE APPLIED TO THIS AREA.

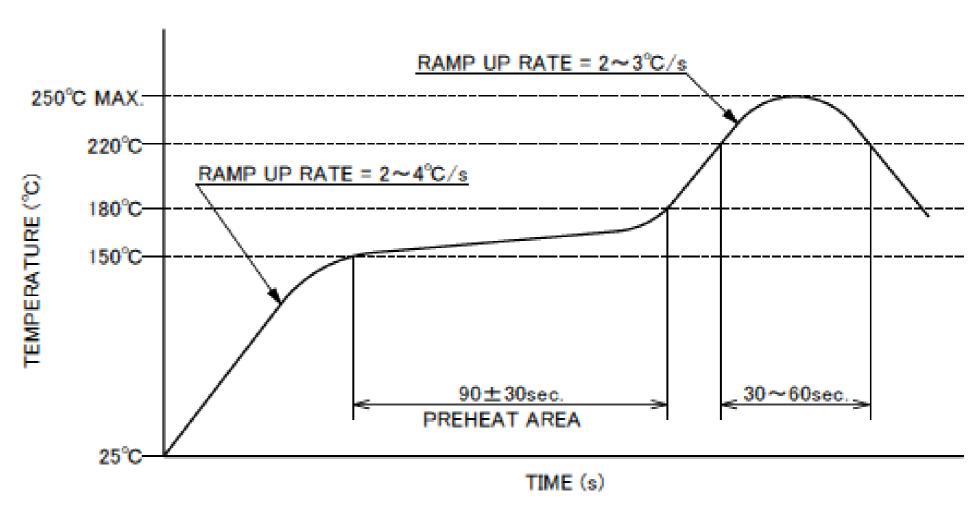


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### **Connector Assembly**







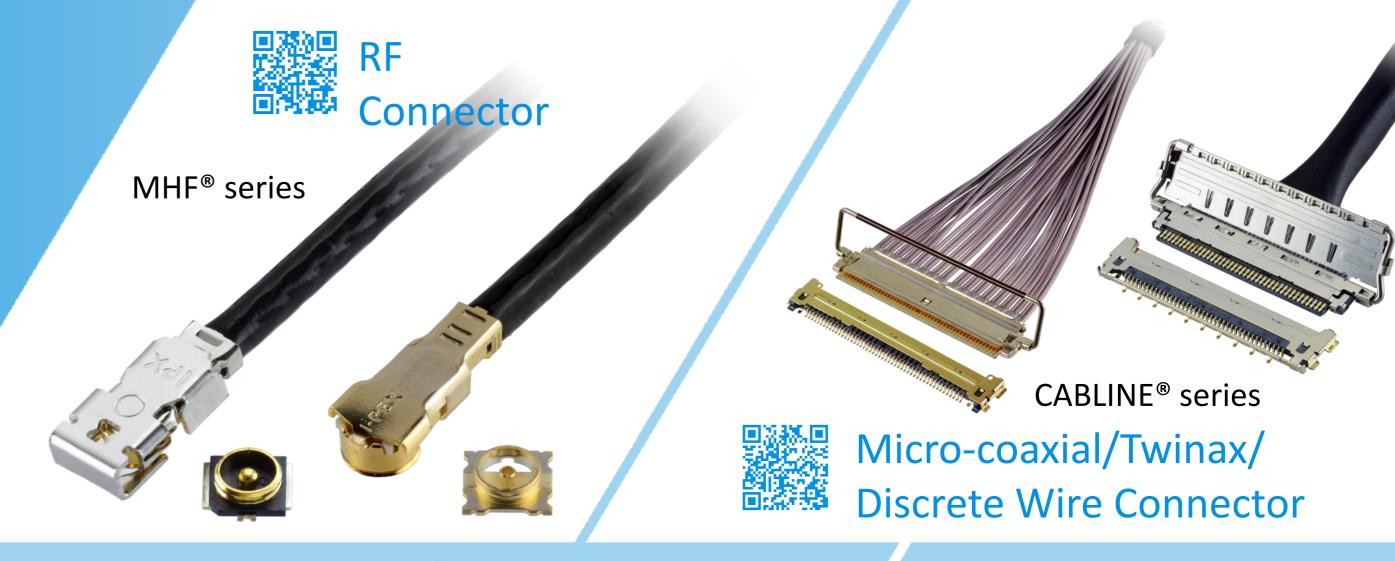
REFLOW TEMPERATURE PROFILE
SENJU METAL INDUSTRY CO., LTD.: M705-SHF(Sn96.5 Ag3.0 Cu0.5)

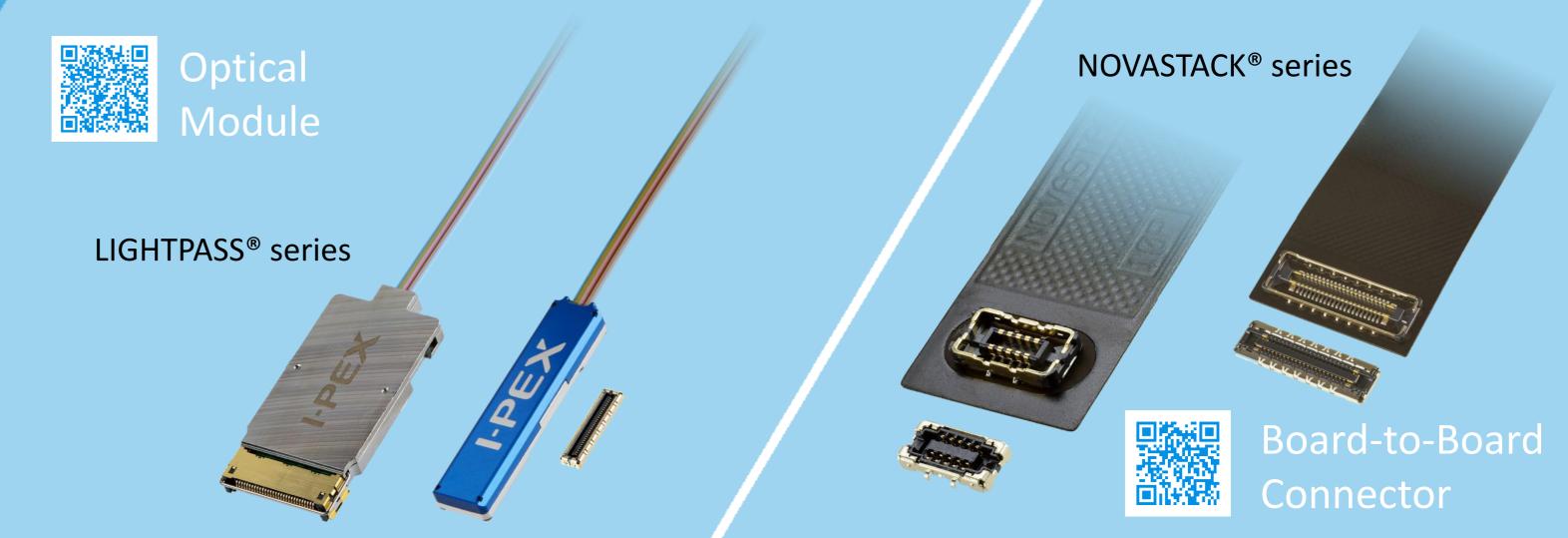
Rev.14

ITEMS	SPECIFICATION			
RATING VOLTAGE	50V AC/DC (PER CONTACT PIN)			
RATING AMPERAGE (FOR CONTACT)	0.50A AC/DC (PER CONTACT PIN) ※(AVAILABLE UP TO 15PIN) / 0.35A AC/DC(PER CONTACT PIN) ※(AVAILABLE FOR ALL PIN)			
OPERATING TEMPERATURE	Using FFC : 233~358K(-40°C~+85°C) Using FPC : 233~398K(-40°C~+125°C)			
OPERATING HUMIDITY	85% MAX.(NON-CONDENSING)			
CONTACT RESISTANCE	INITIAL : 70mohm MAX. / AFTER TEST : ⊿40mohm MAX.			
INSULATION RESISTANCE	INITIAL: 500Mohm MIN. / AFTER TEST: 500Mohm MIN.			
DIELECTRIC WITHSTANDING VOLTAGE	AC 250V 1min			
DURABILITY	30 CYCLES			
MATING FORCE (INITIAL / AFTER TEST)	10P: 6.0N MAX. 15P: 9.0N MAX. 22P: 13.2N MAX. 30P: 18.0N MAX. 40P: 24.0N MAX. 45P: 27.0N MAX. 50P: 30.0N MAX. 50P: 33.0N MAX. 50P: 36.0N MAX.			
UNMATING FORCE (INITIAL / AFTER TEST)	10P: 0.90N MIN. 15P: 1.35N MIN. 22P: 1.98N MIN. 30P: 2.70N MIN. 40P: 3.60N MIN. 45P: 4.05N MIN. 50P: 4.50N MIN. 50P: 4.95N MIN. 50P: 5.40N MIN.			
COPLANARITY	0.10mm MAX.			
PRODUCT SPECIFICATION	PRS-1562			
TEST REPORT	TR-10048			
PACKING STANDARD	300-861			
INSTRUCTION MANUAL	HIM-10008			
APPEARANCE CRITERIA No.	QLS-A***			

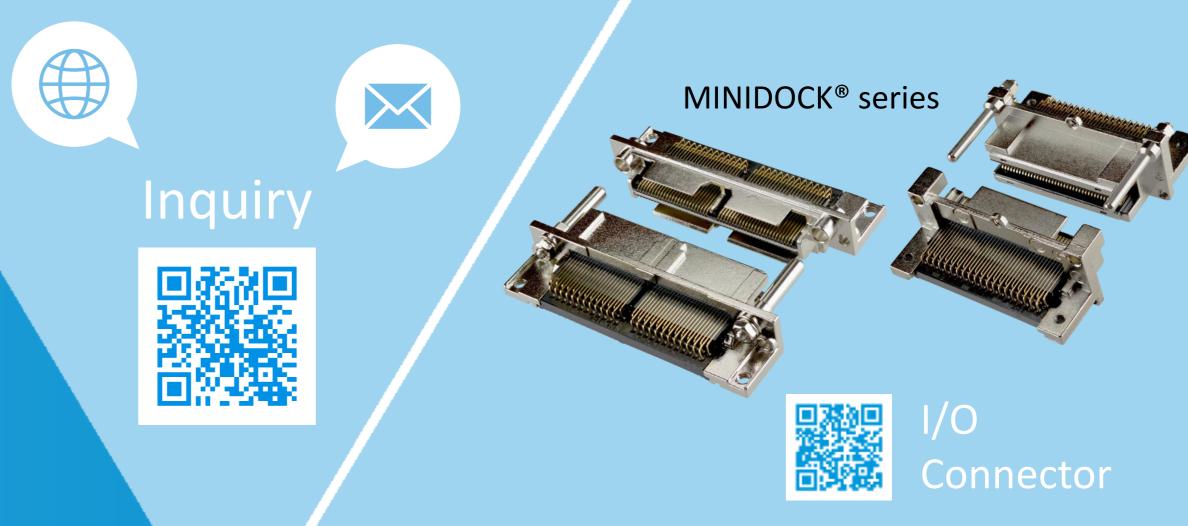


## Custom Connectors Available









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Contact your sales representative or more detailed information.

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